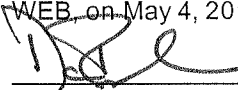


**CERTIFICATE OF ELECTRONIC
TRANSMISSION**

I hereby certify that this correspondence for Application No. 10/524,525 is being electronically transmitted to Technology Center 1792, via EFS-WEB, on May 4, 2010.



David H. Brinkman, Reg. No. 40,532

5/4/10

Date

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Martin Hausner
Serial No. : 10/524,525
Filed : August 18, 2005
Confirmation No. : 1134
Group Art Unit : 1792
Examiner : Ahmed, Shamim
Title : **METHOD FOR SELECTIVELY REMOVING MATERIAL
FROM THE SURFACE OF A SUBSTRATE, MASKING
MATERIAL FOR A WAFER, AND WAFER WITH MASKING
MATERIAL**
Attorney Docket No. : BEET-09

Cincinnati, Ohio 45202

May 4, 2010

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

SUPPLEMENTAL AMENDMENT

In response to the Office Action mailed on November 3, 2009 and supplementing the Amendment filed on May 3, 2010, please amend the above-identified application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 11 of this paper.